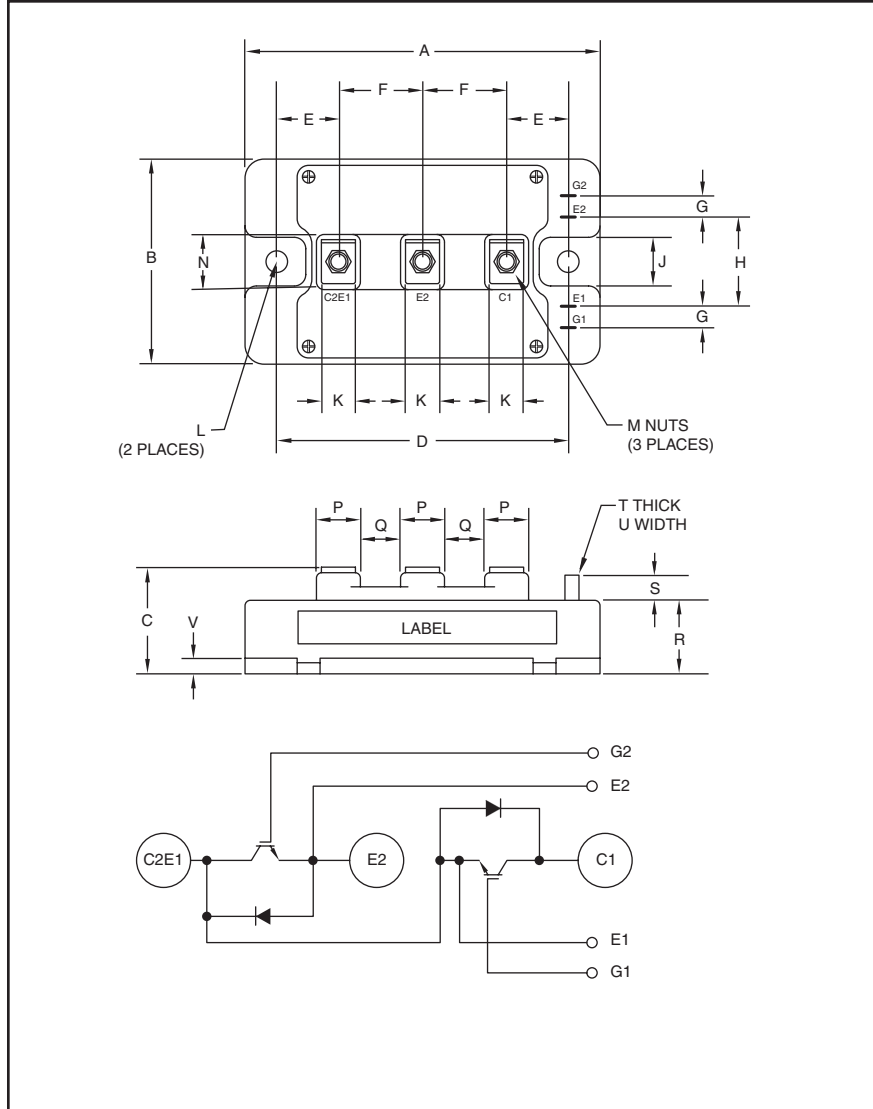


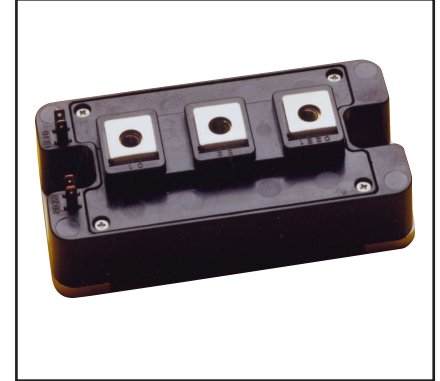
### Dual IGBTMOD™ A-Series Module 150 Amperes/1200 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	3.70	94.0
B	1.89	48.0
C	1.14+0.004/-0.02	29.0+0.1/-0.5
D	3.15±0.01	80.0±0.25
E	0.67	17.0
F	0.91	23.0
G	0.16	4.0
H	0.71	18.0
J	0.51	13.0
K	0.47	12.0

Dimensions	Inches	Millimeters
L	0.26 Dia.	Dia. 6.5
M	M5 Metric	M5
N	0.79	20.0
P	0.63	16.0
Q	0.28	7.0
R	0.83	21.2
S	0.30	7.5
T	0.02	0.5
U	0.110	2.8
V	0.16	4.0



#### Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of two IGBT Transistors in a half-bridge configuration with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

#### Features:

- ☐ Low Drive Power
- ☐ Low  $V_{CE(sat)}$
- ☐ Discrete Super-Fast Recovery Free-Wheel Diode
- ☐ Isolated Baseplate for Easy Heat Sinking

#### Applications:

- ☐ AC Motor Control
- ☐ UPS
- ☐ Battery Powered Supplies

#### Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM150DY-24A is a 1200V ( $V_{CES}$ ), 150 Ampere Dual IGBTMOD™ Power Module.

Type	Current Rating Amperes	$V_{CES}$ Volts (x 50)
CM	150	24

**CM150DY-24A**  
**Dual IGBTMOD™ A-Series Module**  
 150 Amperes/1200 Volts

**Absolute Maximum Ratings,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Ratings	Symbol	CM150DY-24A	Units
Junction Temperature	$T_j$	-40 to 150	$^\circ\text{C}$
Storage Temperature	$T_{\text{stg}}$	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E Short)	$V_{\text{CES}}$	1200	Volts
Gate-Emitter Voltage (C-E Short)	$V_{\text{GES}}$	$\pm 20$	Volts
Collector Current (DC, $T_C = 83^\circ\text{C}^*$ )	$I_C$	150	Amperes
Peak Collector Current	$I_{\text{CM}}$	300**	Amperes
Emitter Current*** ( $T_C = 25^\circ\text{C}$ )	$I_E$	150	Amperes
Peak Emitter Current***	$I_{\text{EM}}$	300**	Amperes
Maximum Collector Dissipation ( $T_C = 25^\circ\text{C}^*$ , $T_j \leq 150^\circ\text{C}$ )	$P_C$	960	Watts
Mounting Torque, M5 Main Terminal	—	30	in-lb
Mounting Torque, M6 Mounting	—	40	in-lb
Weight	—	310	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	$V_{\text{ISO}}$	2500	Volts

**Static Electrical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	$I_{\text{CES}}$	$V_{\text{CE}} = V_{\text{CES}}$ , $V_{\text{GE}} = 0\text{V}$	—	—	1.0	mA
Gate Leakage Current	$I_{\text{GES}}$	$V_{\text{GE}} = V_{\text{GES}}$ , $V_{\text{CE}} = 0\text{V}$	—	—	0.5	$\mu\text{A}$
Gate-Emitter Threshold Voltage	$V_{\text{GE(th)}}$	$I_C = 15\text{mA}$ , $V_{\text{CE}} = 10\text{V}$	6.0	7.0	8.0	Volts
Collector-Emitter Saturation Voltage	$V_{\text{CE(sat)}}$	$I_C = 150\text{A}$ , $V_{\text{GE}} = 15\text{V}$ , $T_j = 25^\circ\text{C}$	—	2.1	3.0	Volts
		$I_C = 150\text{A}$ , $V_{\text{GE}} = 15\text{V}$ , $T_j = 125^\circ\text{C}$	—	2.4	—	Volts
Total Gate Charge	$Q_G$	$V_{\text{CC}} = 600\text{V}$ , $I_C = 150\text{A}$ , $V_{\text{GE}} = 15\text{V}$	—	675	—	nC
Emitter-Collector Voltage**	$V_{\text{EC}}$	$I_E = 150\text{A}$ , $V_{\text{GE}} = 0\text{V}$	—	—	3.8	Volts

**Dynamic Electrical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	$C_{\text{ies}}$	$V_{\text{CE}} = 10\text{V}$ , $V_{\text{GE}} = 0\text{V}$	—	—	23	nf
Output Capacitance	$C_{\text{oes}}$		—	—	2	nf
Reverse Transfer Capacitance	$C_{\text{res}}$		—	—	0.45	nf
Inductive	Turn-on Delay Time	$V_{\text{CC}} = 600\text{V}$ , $I_C = 150\text{A}$ , $V_{\text{GE1}} = V_{\text{GE2}} = 15\text{V}$ , $R_G = 2.1\Omega$ , Inductive Load	—	—	130	ns
Load	Rise Time		—	—	100	ns
Switch	Turn-off Delay Time		—	—	450	ns
Time	Fall Time		—	—	350	ns
Diode Reverse Recovery Time***	$t_{\text{rr}}$	Switching Operation,	—	—	150	ns
Diode Reverse Recovery Charge***	$Q_{\text{rr}}$	$I_E = 150\text{A}$	—	6.0	—	$\mu\text{C}$

\* $T_C$ ,  $T_f$  measured point is just under the chips.

\*\*Pulse width and repetition rate should be such that device junction temperature ( $T_j$ ) does not exceed  $T_{j(\text{max})}$  rating.

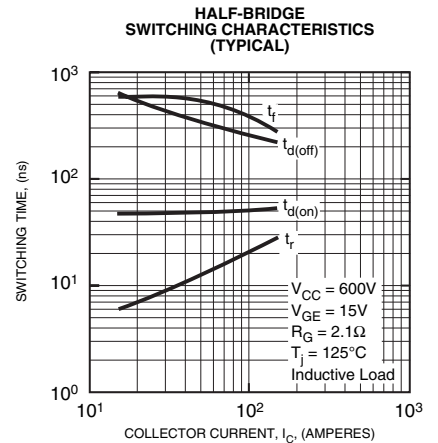
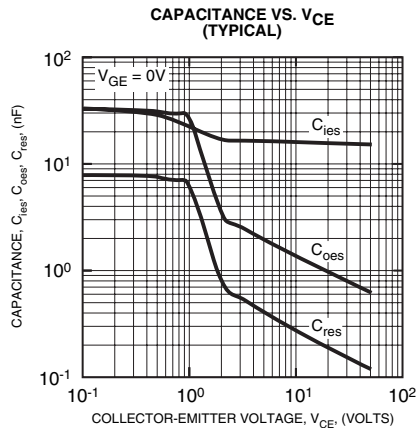
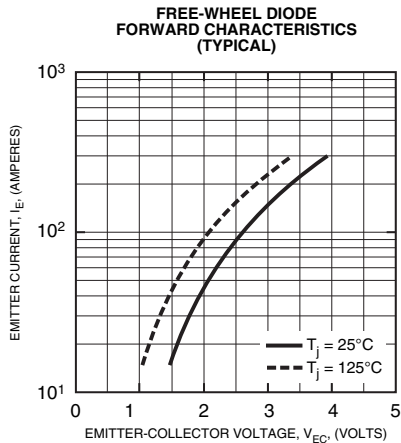
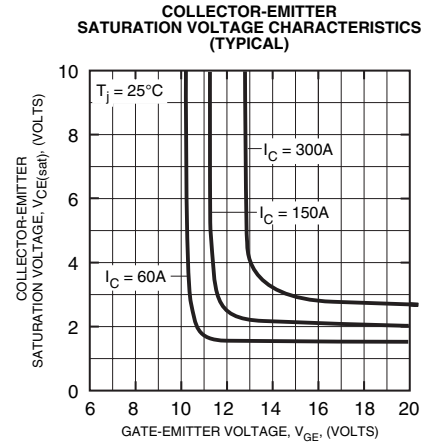
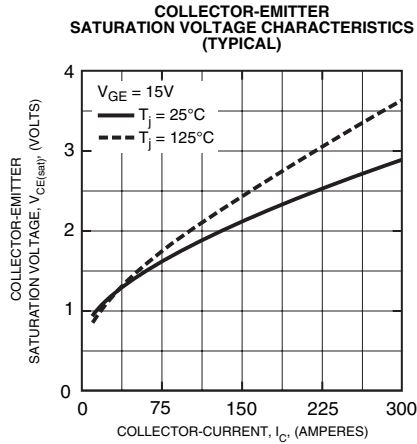
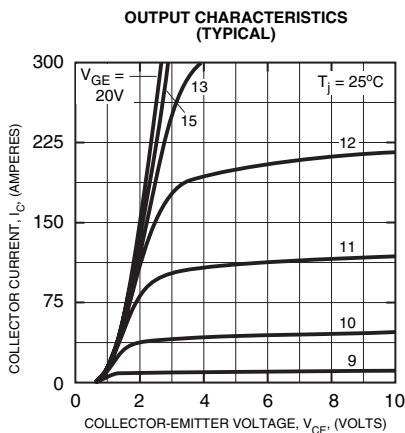
\*\*\*Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDI).

**CM150DY-24A**  
**Dual IGBTMOD™ A-Series Module**  
 150 Amperes/1200 Volts

**Thermal and Mechanical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case*	$R_{th(j-c)Q}$	Per IGBT 1/2 Module	—	—	0.13	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case*	$R_{th(j-c)D}$	Per FWDi 1/2 Module	—	—	0.23	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per 1/2 Module, Thermal Grease Applied	—	0.022	—	$^\circ\text{C/W}$
External Gate Resistance	$R_G$		2.1	—	31	$\Omega$

\* $T_C$ ,  $T_f$  measured point is just under the chips.

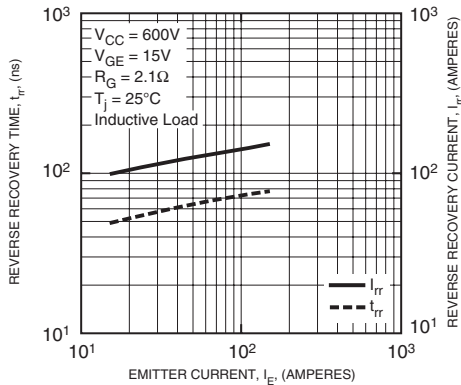


## CM150DY-24A

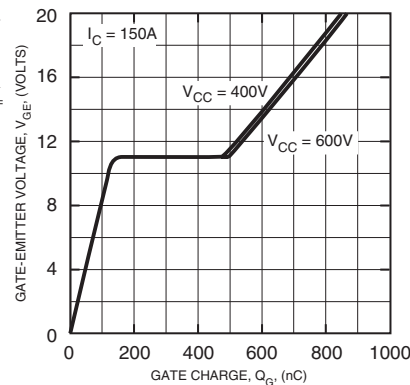
### Dual IGBTMOD™ A-Series Module

150 Amperes/1200 Volts

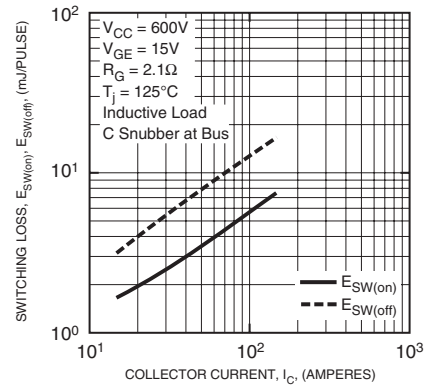
REVERSE RECOVERY CHARACTERISTICS  
(TYPICAL)



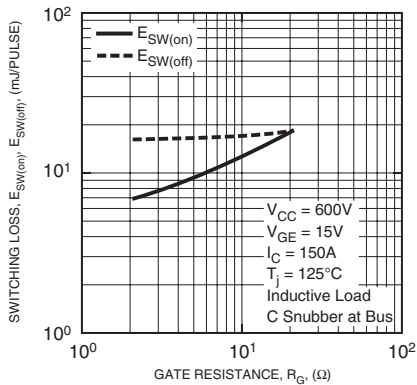
GATE CHARGE VS.  $V_{GE}$



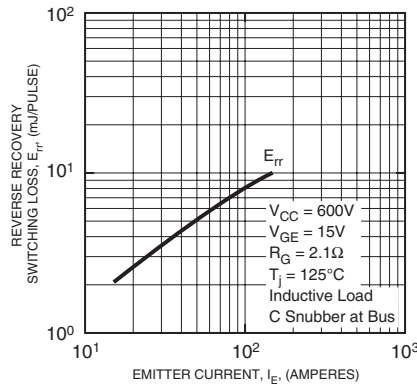
SWITCHING LOSS VS.  
COLLECTOR CURRENT (TYPICAL)



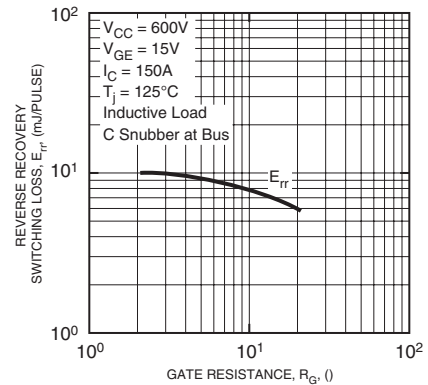
SWITCHING LOSS VS.  
GATE RESISTANCE (TYPICAL)



REVERSE RECOVERY SWITCHING LOSS VS.  
EMITTER CURRENT  
(TYPICAL)



REVERSE RECOVERY SWITCHING LOSS VS.  
GATE RESISTANCE  
(TYPICAL)



TRANSIENT THERMAL  
IMPEDANCE CHARACTERISTICS  
(IGBT & FWDI)

